ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® Material Comp © Copyright 2005. I international and Par	PC. Bannock	burn. Illinois. A	Il rights reserved nations.	under both	This docum level parts, t	ent is a declara	tion of the s	substances es all lowe	within the er level ma	e manufacture terials for wh	er listed ite nich the ma	m. Note: i nufacture	f the item is an as has engineering	sembly with lower responsibility.
	I.1IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175xForm Dist				 Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi 					eous Materia	als and Mfg Information			
Supplier Information														
Company name*	Company unique ID			Unique ID Authority					Response Date*					
onsemi Contact Name Title - Co			le - Contact			Phone - Contact*					2023-06-08 Email - Contact*			
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title			Title - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Iter	n Number	Number Mfr Item Name			Effective Da	e Version	1	Manufacturing Site		W	eight*	UOM	Unit Type
	ADM10 REEL	23ARQZ-	THERMAL DIODE MONITOR IC		. IC	2023-06-08			PH1		77	.0	mg	Each
Manufacturing Proccess Informa	tion													
Terminal Plating / Grid Array Ma	Terminal Plating / Grid Array Material Terminal Base A		Alloy	J-STD-020 MSL Rating		Peak Process Body Temperatur		re Max Time at Peak Temper		Temperatu	e Numb	er of Reflow Cyd	les	
Matte Tin (Sn) - annealed CU Al		CU Alloy	1			260	260 C 3		30		seconds 3			
Comments														
level 1 - maximum time at peak temperatu	re during so	oldering is 10-3	0 seconds											
For more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	HS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl halate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the							
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.3	mg	Supplier	Silicon (Si)	7440-21-3		1.3	mg
Die Attach	0.31	mg	Supplier	Silver (Ag)	7440-22-4		0.2325	mg
			Supplier	Epoxy resins	129915-35-1		0.0775	mg
Lead Frame	31.11	mg	Supplier	Silver (Ag)	7440-22-4		0.4449	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0373	mg
			Supplier	Iron (Fe)	7439-89-6		0.7218	mg
			Supplier	Copper (Cu)	7440-50-8		29.8967	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0093	mg
Mold Compound-Black	43.0	mg		Epoxy Phenol Resin	proprietary data		4.515	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.485	mg
Plating	0.86	mg	Supplier	Tin (Sn)	7440-31-5		0.86	mg
Wire Bond - Au	0.42	mg	Supplier	Gold (Au)	7440-57-5		0.42	mg